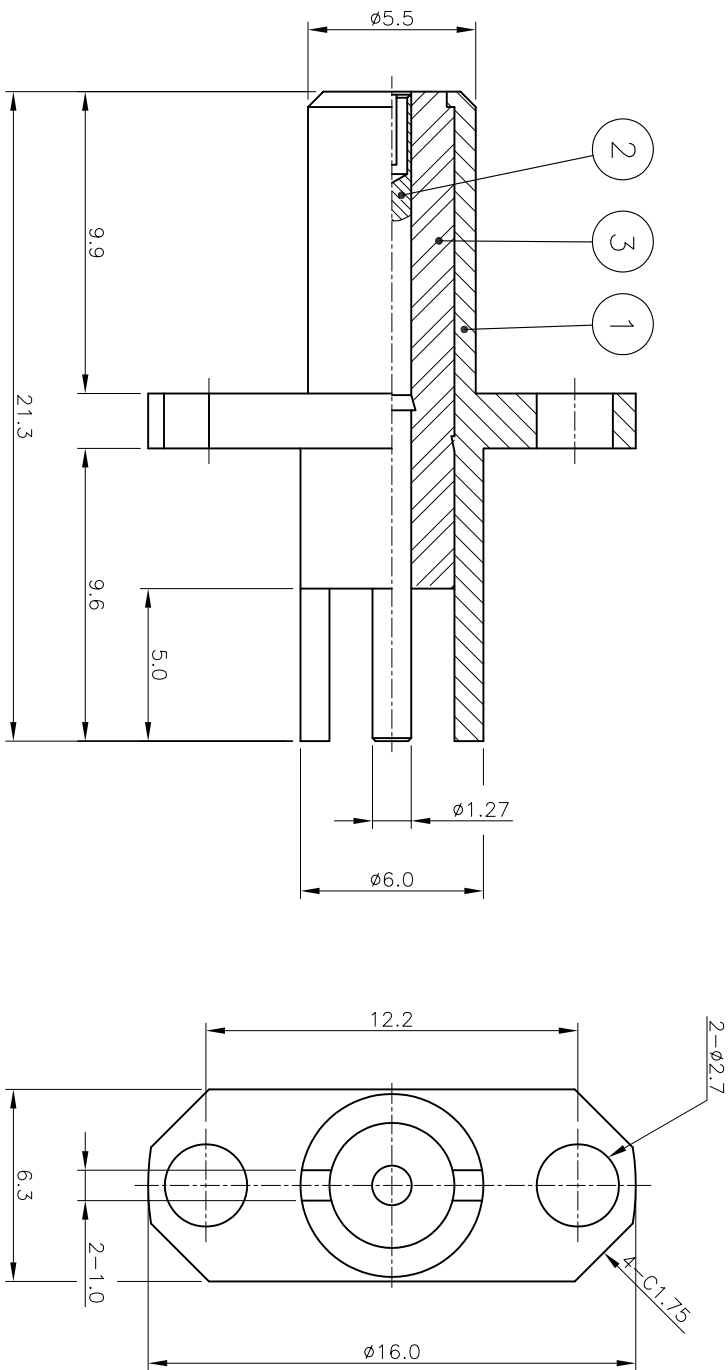


REVISION			DATE
REV	DESCRIPTION		
1R	최초 개정	2009. 03. 03.	



3	INSULATOR	1	TEFLON		DIN01351-N/1 (H2361)
2	CONTACT	1	BeCu	Gold Plate	DCT01632-5/1 (E2359)
1	BODY	1	MBSBD	Nickel Plate	DBD02408-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

DATE 2009. 03. 03.

APPROVED BY S.J.YOUN

CHECKED BY I.C.KIM

DRAWN BY E.H.KIM

FINISH -

SCALE 5/1 UNIT mm

A4 DWG NO. CN02346-7/1 (K314-430-015)

KJ COMTECH
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SMA50 SOLDER END J-H2-R2-R